

## **Excellent Integrated System Limited**

Stocking Distributor

Click to view price, real time Inventory, Delivery & Lifecycle Information:

[Cree Inc.](#)  
[XMLCTW-A0-0000-00C3ACAA1](#)

For any questions, you can email us directly:

[sales@integrated-circuit.com](mailto:sales@integrated-circuit.com)

## Cree® XLamp® XM-L Color LEDs



### PRODUCT DESCRIPTION

The XLamp® XM-L Color LED is a multi-color LED that provides high lumen output in a small package. Compared to discrete LEDs, XLamp XM-L Color LEDs reduce the distance between LED die, creating a small optical source for excellent optical control and efficient color mixing. XLamp XM-L Color LEDs can reduce LED system complexity by reducing the number of components required.

Cree XLamp XM-L Color LEDs bring high performance and quality of light to a wide range of lighting applications, including color-changing lighting, stage lighting, architectural lighting, indoor directional lighting, and entertainment lighting.

### FEATURES

- Available in red, green, blue and white in a single 5 mm x 5 mm package
- Maximum drive current per LED die: 1 A
- Individually addressable LEDs
- Reflow solderable – JEDEC J-STD-020
- Electrically neutral thermal path
- RoHS-compliant

### TABLE OF CONTENTS

Characteristics - Complete Package .....	2
Characteristics - Per LED Die.....	2
Flux Characteristics .....	3
Relative Spectral Power Distribution .....	3
Relative Flux vs Junction Temperature..	4
Electrical Characteristics.....	4
Relative Flux vs. Current .....	5
Typical Spatial Distribution.....	5
Bin and Order Code Formats.....	6
Performance Groups – Brightness .....	6
Performance Groups – Chromaticity....	7
Performance Groups – Dominant Wavelength.....	7
Standard Order Codes and Bins .....	8
Reflow Soldering Characteristics.....	9
Notes .....	10
Mechanical Dimensions .....	11
Tape and Reel.....	12
Packaging.....	13

## CHARACTERISTICS - COMPLETE PACKAGE

The following table lists the product characteristics for the XLamp XM-L Color LED package, measured with all LED dies on simultaneously and each LED die connected to independent drive circuits at 350 mA.

Characteristics	Unit	Minimum	Typical	Maximum
Thermal resistance, junction to solder point	°C/W		3.5	
Viewing angle (FWHM)	degrees (°)		130	
ESD withstand voltage (HBM per Mil-Std-883D)	V			8000
LED junction temperature	°C			150

## CHARACTERISTICS - PER LED DIE

The following table lists the product characteristics for each LED die within the XLamp XM-L Color LED package.

Characteristics	Unit	Minimum	Typical	Maximum
Temperature coefficient of voltage - red	mV/°C		-1.8	
Temperature coefficient of voltage - green	mV/°C		-4	
Temperature coefficient of voltage - blue, white	mV/°C		-3	
DC forward current - red, green, blue, white	mA			1000
Forward voltage (@ 350 mA, 25 °C) - red	V		2.25	2.6
Forward voltage (@ 350 mA, 25 °C) - green	V		3.3	3.9
Forward voltage (@ 350 mA, 25 °C) - blue, white	V		3.1	3.7

### FLUX CHARACTERISTICS, ( $T_J = 25^\circ\text{C}$ )

The following tables provide several base order codes for XM-L Color LEDs. For a complete description of the order code nomenclature, please refer to the Bin and Order Code Formats section (page 6).

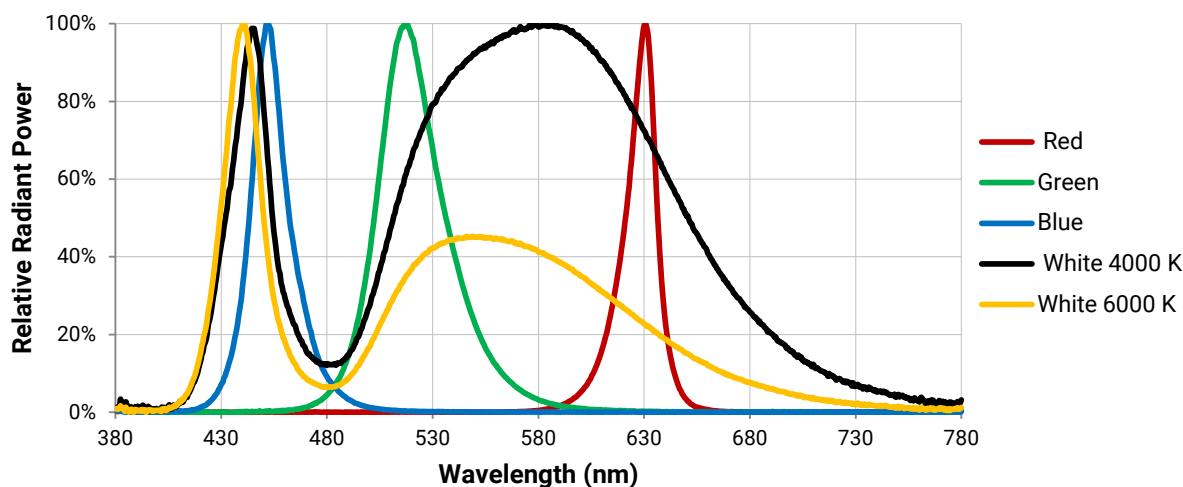
Color		CCT / Dominant Wavelength Range		Minimum Luminous Flux @ 350 mA		Order Code
		Min.	Max.	Group	Flux (lm)	
Color + Cool White	Red	620 nm	630 nm	C3	45.7	XMLCTW-A0-0000-00C3AAAA1
	Green	520 nm	535 nm		87.4	
	Blue	450 nm	465 nm		13.9	
	Cool White	5700 K	8000 K		100	
Color + Neutral White	Red	620 nm	630 nm	C2	45.7	XMLCTW-A0-0000-00C2AAAB1
	Green	520 nm	535 nm		87.4	
	Blue	450 nm	465 nm		13.9	
	Neutral White	3700 K	4300 K		80	

#### Notes:

- Cree maintains a tolerance of  $\pm 7\%$  on flux and power measurements,  $\pm 0.005$  on chromaticity (CCx, CCy) measurements and  $\pm 1$  nm on dominant wavelength measurements. See the Measurements section (page 10).
- Flux and chromaticity are measured with each LED die connected to independent drive circuits at 350 mA. The flux and chromaticity of each LED die within the XLamp XM-L Color LED package are measured individually.

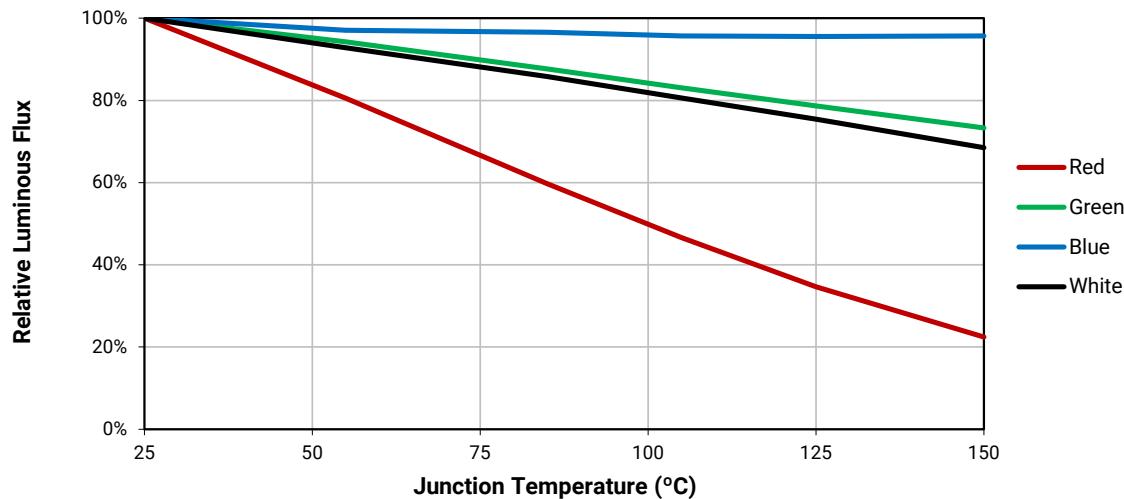
### RELATIVE SPECTRAL POWER DISTRIBUTION ( $I_F = 350 \text{ mA}$ PER LED DIE, $25^\circ\text{C}$ )

The following graph represents typical spectral output of the XLamp XM-L Color LED with each LED die on independently.



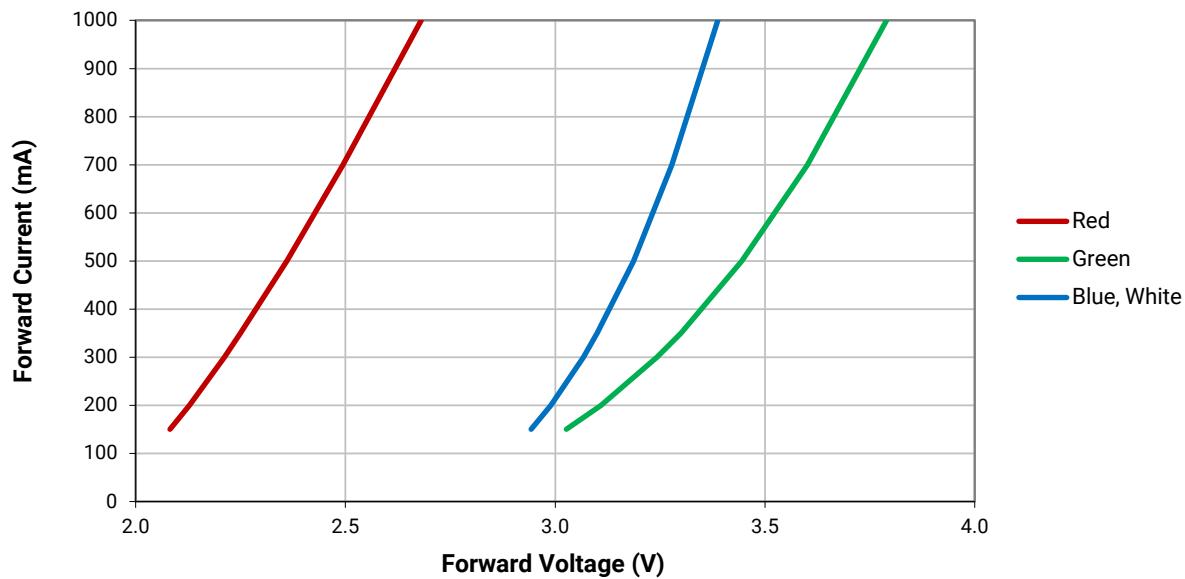
### RELATIVE FLUX VS JUNCTION TEMPERATURE ( $I_F = 350$ mA)

The following graph represents typical performance of each LED die in the XLamp XM-L Color LED.



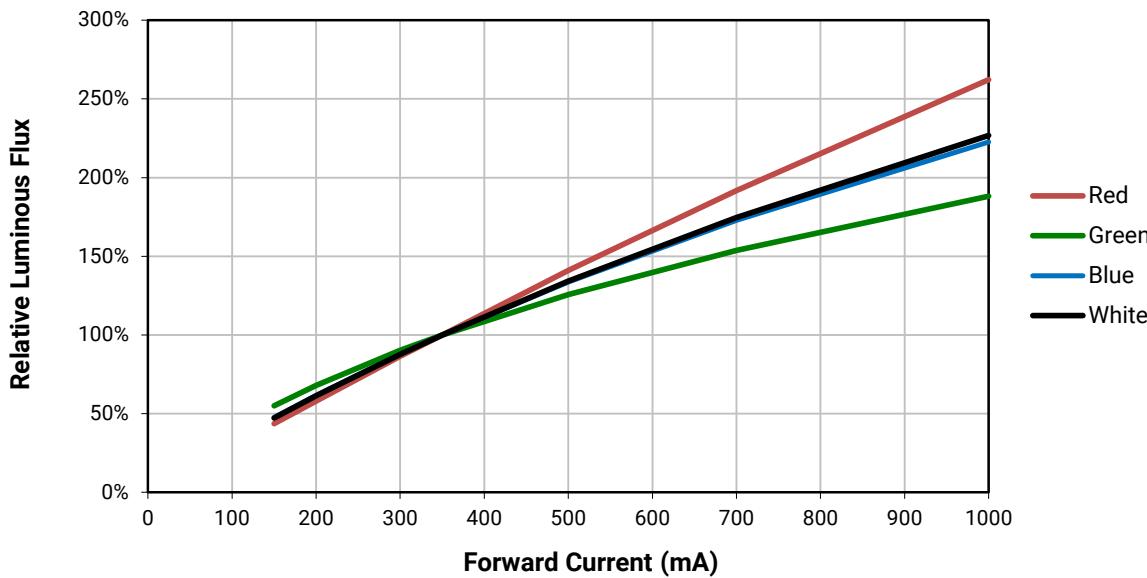
### ELECTRICAL CHARACTERISTICS ( $T_J = 25$ °C)

The following graph represents typical performance of each LED die in the XLamp XM-L Color LED.



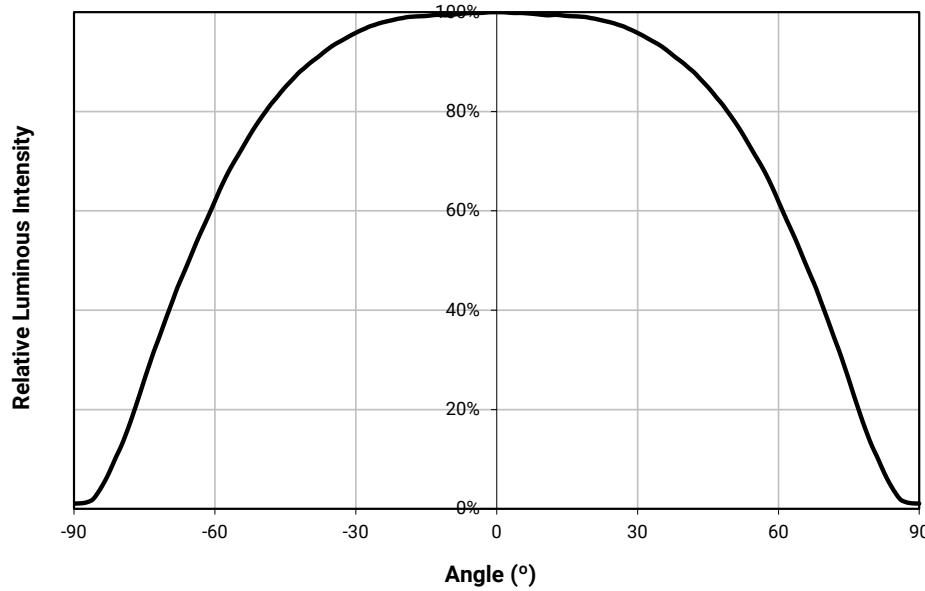
### RELATIVE FLUX VS. CURRENT ( $T_J = 25^\circ\text{C}$ )

The following graph represents typical performance of each LED die in the XLamp XM-L Color LED.



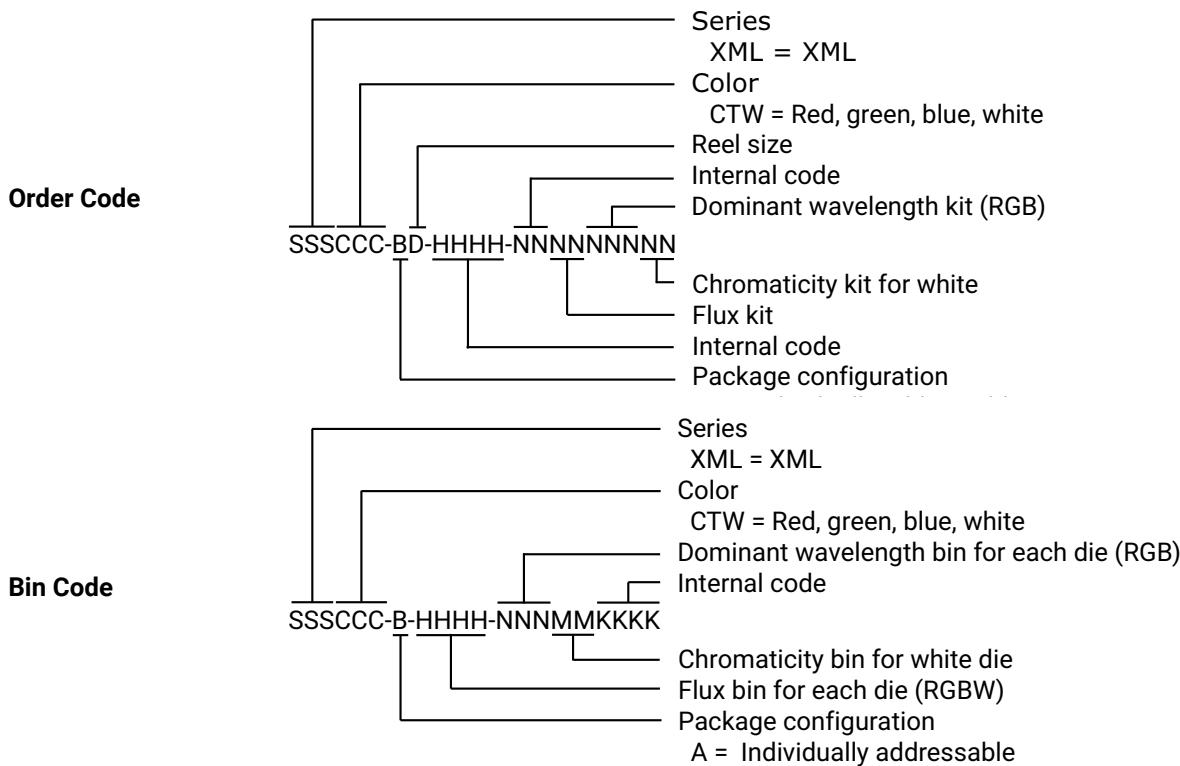
### TYPICAL SPATIAL DISTRIBUTION

The following graph represents typical output of the XLamp XM-L Color LED with all four LEDs on simultaneously.



## BIN AND ORDER CODE FORMATS

Bin codes and order codes are configured in the following manner:



## PERFORMANCE GROUPS – BRIGHTNESS

Each LED die in the XLamp XM-L Color LED is tested individually for luminous flux and placed into one of the following luminous-flux groups.

Color	Group Code	Minimum Luminous Flux (lm) @ 350 mA	Maximum Luminous Flux (lm) @ 350 mA
Red	M	45.7	87.4
	N	87.4	114
Green	N	87.4	114
	P	114	148
Blue	F	13.9	39.8
White	2	80	100
	3	100	120
	4	120	140

- Flux and chromaticity are measured with each LED die connected to independent drive circuits at 350 mA.

### PERFORMANCE GROUPS – CHROMATICITY ( $I_F = 350$ mA PER LED DIE)

The white LED die in the XLamp XM-L Color LED is individually tested for chromaticity at 350 mA and placed into one of the regions defined by the bounding coordinates shown below.

Region	x	y	Region	x	y
WM	.295	.297	WC	.316	.332
	.308	.311		.317	.319
	.310	.300		.308	.311
	.298	.288		.306	.322
WB	.306	.322	WF	.314	.355
	.308	.311		.316	.332
	.295	.297		.306	.322
	.292	.306		.301	.342
WE	.301	.342	WD	.329	.345
	.306	.322		.329	.330
	.292	.306		.317	.319
	.287	.321		.316	.332
WN	.308	.311	WG	.329	.369
	.317	.319		.329	.345
	.318	.308		.316	.332
	.310	.300		.314	.355

Region	x	y									
5A	.3670	.3578	5B	.3702	.3722	5C	.3825	.3798	5D	.3783	.3646
	.3702	.3722		.3736	.3874		.3869	.3958		.3825	.3798
	.3825	.3798		.3869	.3958		.4006	.4044		.3950	.3875
	.3783	.3646		.3825	.3798		.3950	.3875		.3898	.3716

### PERFORMANCE GROUPS – DOMINANT WAVELENGTH

The red, green and blue LED dies in the XLamp XM-L Color LED are tested individually for dominant wavelength (DWL) and sorted into one of the DWL bins defined below.

Color	DWL Group	Minimum DWL @ 350 mA	Maximum DWL @ 350 mA
Blue	K	450	455
	L	455	460
	M	460	465
Green	2	520	525
	3	525	530
	4	530	535
Red	A	620	630

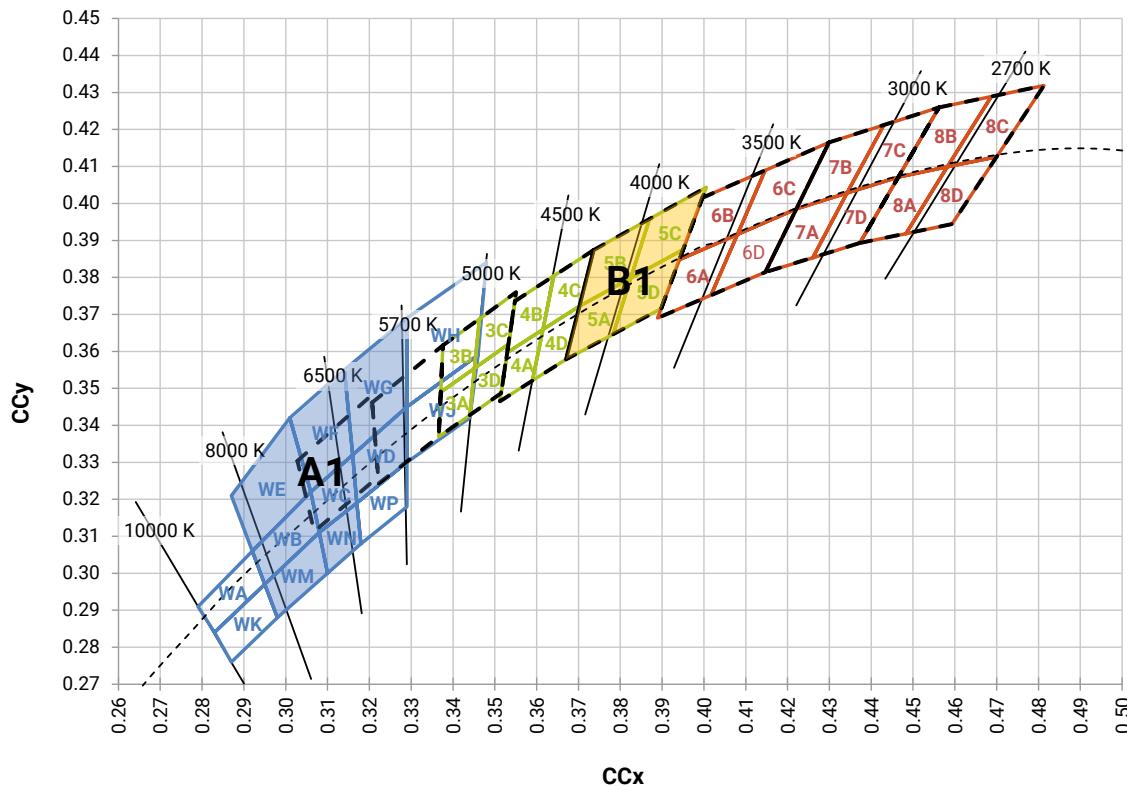
## STANDARD ORDER CODES AND BINS

The following tables list standard kit numbers and performance bins. Kit numbers completely describe an order code's color or chromaticity bins and luminous flux range.

XLamp XM-L Color LED Standard Order Codes				
Color	Minimum Luminous Flux (lm) @ 350 mA*		DWL / Chromaticity Bins	Kit Number
	Group	Flux (lm)		
Red	M	45.7	A	00C3AAAA1
Green	N	87.4	2, 3, 4	
Blue	F	13.9	K, L, M	
White	3	100	WC, WD, WF, WG, WB, WE, WM, WN	
Red	M	45.7	A	00C2AAAB1
Green	N	87.4	2, 3, 4	
Blue	F	13.9	K, L, M	
White	2	80	5A, 5B, 5C, 5D	

For other flux and chromaticity combinations, contact Cree or an authorized distributor.

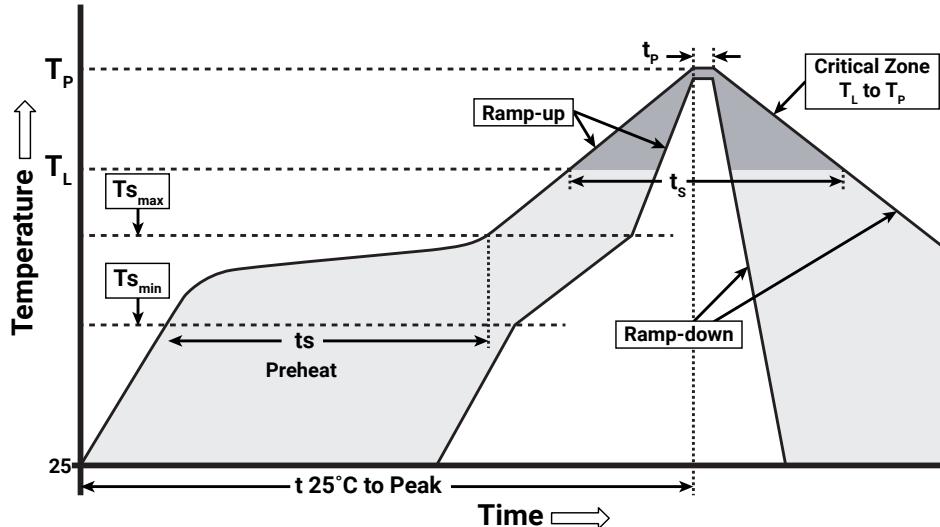
- \* Cree XLamp XM-L Color LED order codes specify only a minimum flux bin and not a maximum. Cree may ship reels in flux bins higher than the minimum specified by the order code without advance notice. Shipments will always adhere to the chromaticity or DWL bin restrictions specified by the order code.



## REFLOW SOLDERING CHARACTERISTICS

In testing, Cree has found XLamp XM-L Color LEDs to be compatible with JEDEC J-STD-020C, using the parameters listed below. As a general guideline, Cree recommends that users follow the recommended soldering profile provided by the manufacturer of the solder paste used.

Note that this general guideline may not apply to all PCB designs and configurations of reflow soldering equipment.



IPC/JEDEC J-STD-020C

Profile Feature	Lead-Free Solder
Average Ramp-Up Rate ( $T_{s_{\max}}$ to $T_p$ )	1.2 °C/second
Preheat: Temperature Min ( $T_{s_{\min}}$ )	120 °C
Preheat: Temperature Max ( $T_{s_{\max}}$ )	170 °C
Preheat: Time ( $t_{s_{\min}}$ to $t_{s_{\max}}$ )	65-150 seconds
Time Maintained Above: Temperature ( $T_L$ )	217 °C
Time Maintained Above: Time ( $t_L$ )	45-90 seconds
Peak/Classification Temperature ( $T_p$ )	235 - 245 °C
Time Within 5 °C of Actual Peak Temperature ( $t_p$ )	20-40 seconds
Ramp-Down Rate	1 - 6 °C/second
Time 25 °C to Peak Temperature	4 minutes max.

Note: All temperatures refer to the topside of the package, measured on the package body surface.

**NOTES****Measurements**

The luminous flux, radiant power, chromaticity and CRI measurements in this document are binning specifications only and solely represent product measurements as of the date of shipment. These measurements will change over time based on a number of factors that are not within Cree's control and are not intended or provided as operational specifications for the products. Calculated values are provided for informational purposes only and are not intended as specifications.

**Pre-Release Qualification Testing**

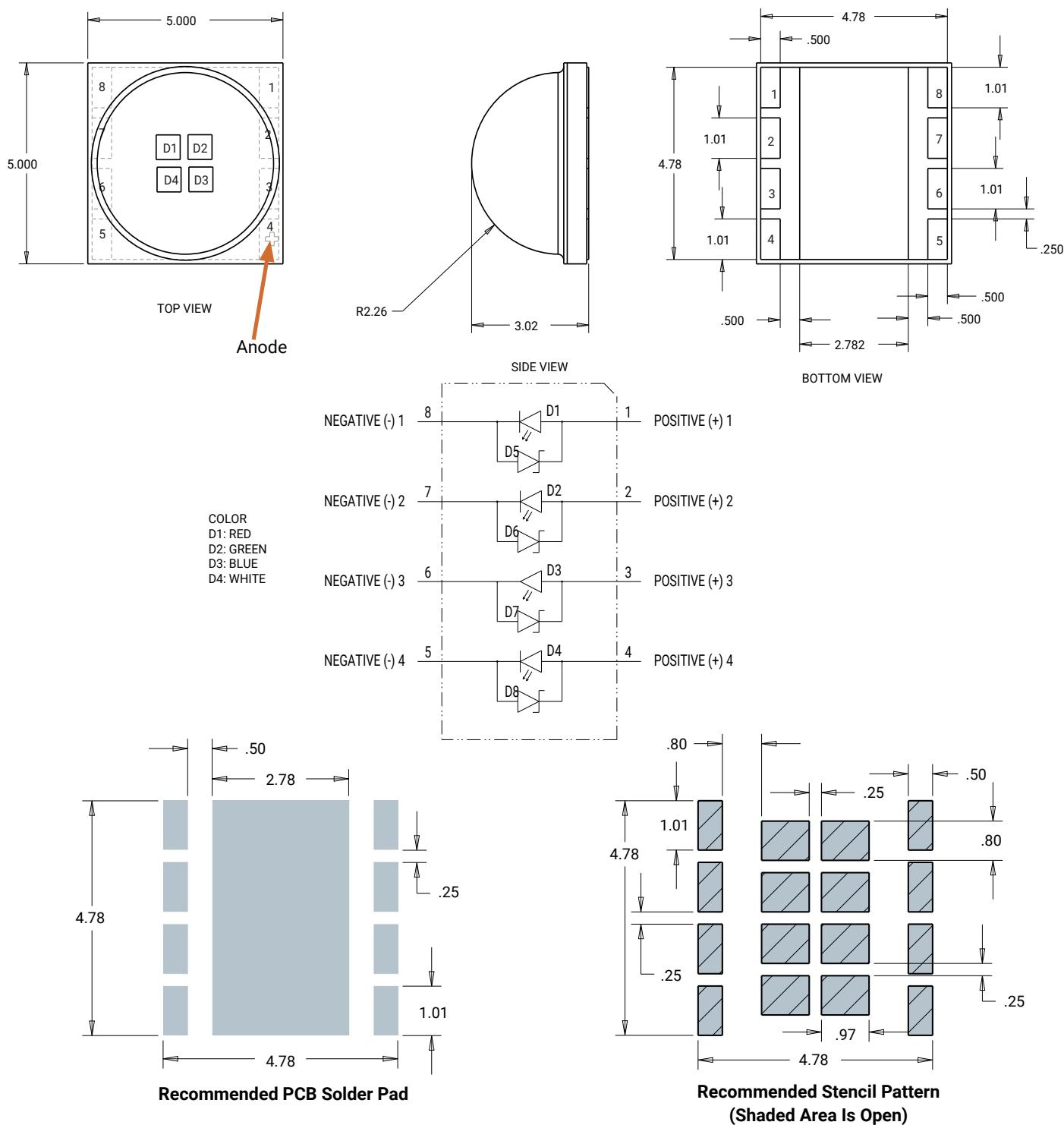
Please read the [LED Reliability Overview](#) for details of the qualification process Cree applies to ensure long-term reliability for XLamp LEDs and details of Cree's pre-release qualification testing for XLamp LEDs.

**RoHS Compliance**

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented January 2, 2013. RoHS Declarations for this product can be obtained from your Cree representative or from the Product Documentation sections of [www.cree.com](http://www.cree.com).

## MECHANICAL DIMENSIONS

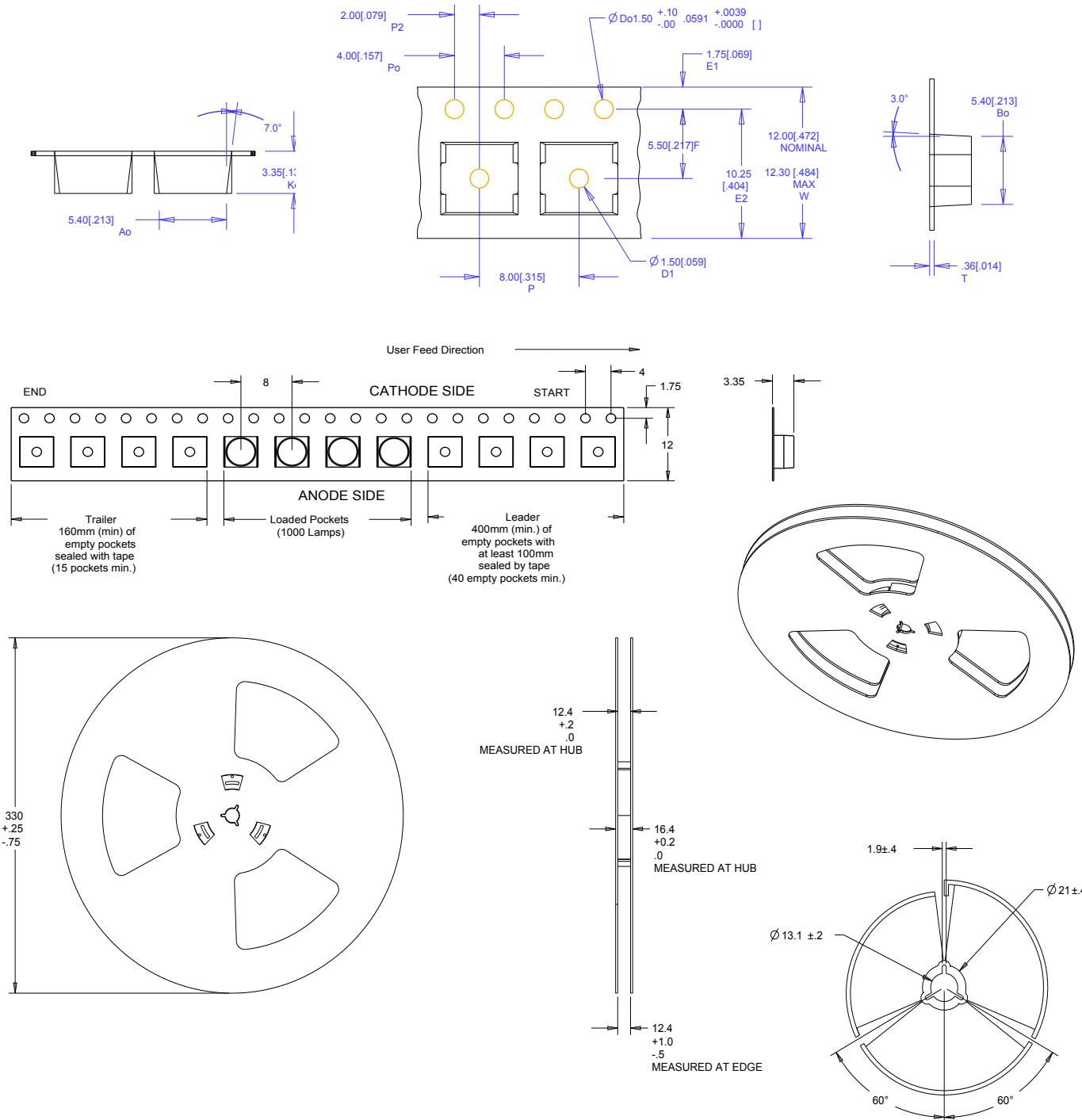
Thermal vias, if present, are not shown on these drawings.



## TAPE AND REEL

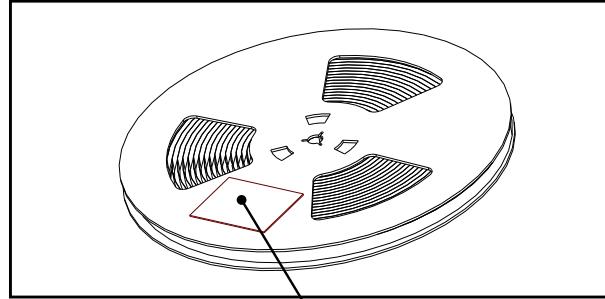
All Cree carrier tapes conform to EIA-481D, Automated Component Handling Systems Standard.

All dimensions in mm.



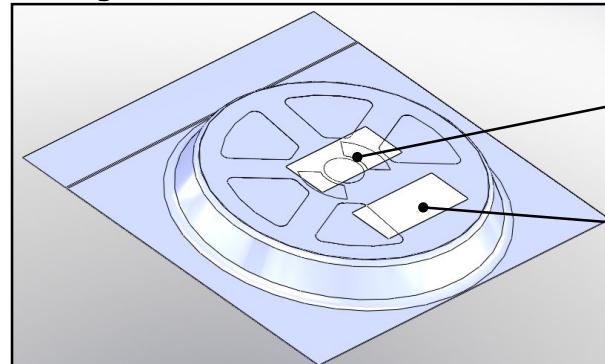
**PACKAGING**

**Unpackaged Reel**



Label with Cree Bin Code,  
Quantity, Reel ID

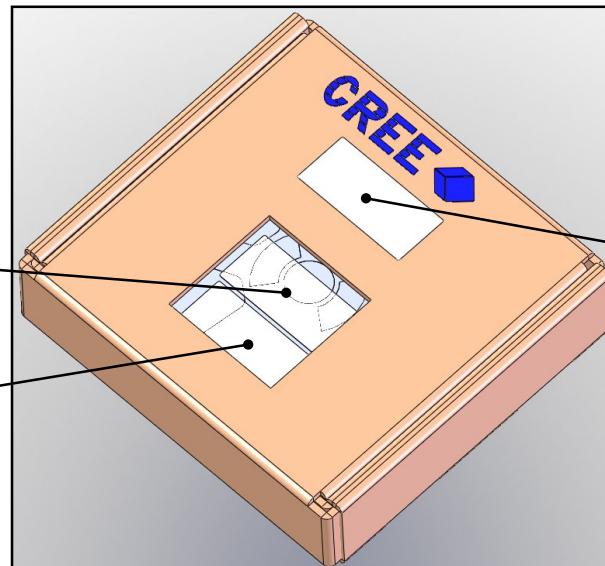
**Packaged Reel**



Label with Cree Order Code,  
Quantity, Reel ID, PO #

Label with Cree Bin Code,  
Quantity, Reel ID

**Boxed Reel**



Label with Cree Order Code,  
Quantity, Reel ID, PO #

Label with Cree Bin Code,  
Quantity, Reel ID

Patent Label